

AMENDMENTS TO THE CLAIMS

1-12 (Canceled)

13-27 (Canceled)

28. (Previously Presented) A system comprising:
a first circuit board comprising a first electrical contact and a first connector;
a second circuit board comprising a second electrical contact and a second connector
configured to be mated to the first connector, wherein
when mated to each other, the first connector and the second connector provide a
first connection for transmitting at least one signal between the first circuit board
and the second circuit board; and
a pin header having at least one pin, the at least one pin passing through at least one hole
in the first circuit board and at least one hole in the second circuit board, one of
the at least one pins configured to make electrical contact with the first electrical
contact and the second electrical contact, wherein
the at least one pin is perpendicular to the first connection between the first
connector and the second connector.
29. (Previously Presented) The system of claim 28, wherein
the second connector is configured to be displaced along a first axis until the second
connector is mated with the first connector;
the first axis is perpendicular to a second axis; and
the at least one pin extends along the second axis.
30. (Previously Presented) The system of claim 28, wherein
when extended through the at least one hole in the first circuit board and the at least one
hole in the second circuit board, the at least one pin provides a second connection
for transmitting at least one signal between the first circuit board and the second
circuit board.

31. (Previously Presented) The system of claim 30, wherein the first connection is an optical connection and a second connection is an electrical connection.
32. (Previously Presented) The system of claim 31, wherein the first connection transmits at least one optical signal between the first circuit board and the second circuit board, and the first connection transmits the at least one optical signal along a first axis.
33. (Previously Presented) The system of claim 32, wherein the second connection transmits at least one electrical signal between the first circuit board and the second circuit board, and the second connection transmits the at least one electrical signal along the second axis.
34. (Previously Presented) The system of claim 31, wherein the optical connection between the first connector and the second connector fixes the first circuit board and the second circuit board in at least a first plane.
35. (Previously Presented) The system of claim 34, wherein the second circuit board is an OC-192 transmit module.
36. (Previously Presented) The system of claim 31, wherein the second circuit board is disposed with zero interconnection height relative to the first circuit board.
37. (Previously Presented) The system of claim 28, further comprising: a pass-through socket, wherein the at least one pin passes through at least one hole in the pass-through socket.
38. (Previously Presented) The system of claim 37, further comprising: a second pass-through socket, wherein the at least one pin passes through at least one hole in the second pass-through socket.

39. (Previously Presented) The system of claim 38, wherein
the pass-through socket is disposed on one side of a combination of the first circuit board
and the second circuit board, and
the second-pass through socket is disposed on an opposite side of the combination of the
first circuit board and the second circuit board.

40. (Previously Presented) The system of claim 28, wherein
electrical contact with the at least one pin is maintained by spring force of the first
electrical contact and the second electrical contact.

41-45 (Canceled)

46. (Previously Presented) The system of claim 40, further comprising:
a pass-through socket, wherein
the means for inserting insert the one or more pins through at least one through-hole in
the pass-through socket.

47. (Previously Presented) The system of claim 46, further comprising:
a second pass-through socket, wherein
the means for inserting insert the one or more pins through at least one hole in the second
pass-through socket.

48. (Previously Presented) The system of claim 47, wherein
the pass-through socket is disposed on one side of a combination of the first circuit board
and the second circuit board, and
the second-pass through socket is disposed on an opposite side of the combination of the
first circuit board and the second circuit board.

49 – 62 (Canceled)